Double-Balanced Mixer
5.5 - 19.0 GHz

Features
- Low Conversion Loss: 6 dB
- Wide IF Bandwidth: DC - 6 GHz
- IIP3 21 dBm @ 15 dBm LO Drive
- High Isolation
- Lead-Free 3 mm 12-lead QFN package
- Lead-free and RoHS* Compliant

Applications
- Test & Measurements
- Microwave Radio
- Radar

Description
MAMX-011035 is a GaAs double-balanced passive diode mixer housed in a lead-free 3 mm, 12-lead QFN package. The mixer offers low conversion loss, high linearity and a wide IF bandwidth. The double-balanced circuit configuration provides excellent port isolation while internal 50 Ω matching simplifies its application.

Ordering Information

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Package</th>
</tr>
</thead>
<tbody>
<tr>
<td>MAMX-011035</td>
<td>Bulk</td>
</tr>
<tr>
<td>MAMX-011035-TR0100</td>
<td>100 Piece Reel</td>
</tr>
<tr>
<td>MAMX-011035-TR0500</td>
<td>500 Piece Reel</td>
</tr>
<tr>
<td>MAMX-011035-SB1</td>
<td>Sample Board</td>
</tr>
</tbody>
</table>

1. Reference Application Note M513 for reel size information.

Functional Schematic

Pin Configuration

<table>
<thead>
<tr>
<th>Pin #</th>
<th>Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>1,3,4,6,7,9</td>
<td>GND</td>
</tr>
<tr>
<td>2</td>
<td>LO</td>
</tr>
<tr>
<td>5</td>
<td>IF</td>
</tr>
<tr>
<td>8</td>
<td>RF</td>
</tr>
<tr>
<td>10 - 12</td>
<td>NC²</td>
</tr>
<tr>
<td>13</td>
<td>GND³</td>
</tr>
</tbody>
</table>

2. MACOM recommends connecting unused package pins to ground.
3. The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.
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MAMX-011035
Rev. V3

Electrical Specifications\(^4\): \(F_{IF} = 100\) MHz, \(P_{LO} = 15\) dBm, \(T_A = +25^\circ\)C, \(Z_0 = 50\) \(\Omega\)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>Units</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
</tr>
</thead>
<tbody>
<tr>
<td>LO and RF Frequency</td>
<td>—</td>
<td>GHz</td>
<td>5.5</td>
<td>—</td>
<td>19</td>
</tr>
<tr>
<td>IF Frequency</td>
<td>—</td>
<td>GHz</td>
<td>0</td>
<td>—</td>
<td>6</td>
</tr>
<tr>
<td>LO Power</td>
<td>—</td>
<td>dBm</td>
<td>—</td>
<td>15</td>
<td>—</td>
</tr>
<tr>
<td>Conversion Loss</td>
<td>5.5 - 19 GHz</td>
<td>dB</td>
<td>—</td>
<td>6</td>
<td>8</td>
</tr>
<tr>
<td>Input P1dB</td>
<td>5.5 - 10 GHz 10 - 19 GHz</td>
<td>dBm</td>
<td>—</td>
<td>8</td>
<td>11</td>
</tr>
<tr>
<td>Input IP3</td>
<td>(P_{RF} = -10) dBm/tone, (\Delta f = 1) MHz 5.5 - 10 GHz 10 - 19 GHz</td>
<td>dBm</td>
<td>—</td>
<td>18</td>
<td>20</td>
</tr>
<tr>
<td>Input IP2</td>
<td>(P_{RF} = -10) dBm/tone, (\Delta f = 1) MHz 5.5 - 10 GHz 10 - 19 GHz</td>
<td>dBm</td>
<td>—</td>
<td>45</td>
<td>—</td>
</tr>
<tr>
<td>LO-to-RF Isolation</td>
<td>5.5 - 10 GHz 10 - 19 GHz</td>
<td>dB</td>
<td>—</td>
<td>38</td>
<td>34</td>
</tr>
<tr>
<td>LO-to-IF Isolation</td>
<td>5.5 - 10 GHz 10 - 19 GHz</td>
<td>dB</td>
<td>28</td>
<td>32</td>
<td>40</td>
</tr>
<tr>
<td>RF-to-IF Isolation</td>
<td>5.5 - 10 GHz 10 - 19 GHz</td>
<td>dB</td>
<td>10</td>
<td>21</td>
<td>15</td>
</tr>
</tbody>
</table>

4. All specifications refer to down-conversion operation, unless otherwise noted.

Absolute Maximum Ratings\(^5,6\)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Absolute Maximum</th>
</tr>
</thead>
<tbody>
<tr>
<td>LO Power</td>
<td>23 dBm</td>
</tr>
<tr>
<td>RF or IF Power</td>
<td>20 dBm</td>
</tr>
<tr>
<td>Junction Temperature(^7)</td>
<td>(+150^\circ)C</td>
</tr>
<tr>
<td>Operating Temperature</td>
<td>(-55^\circ)C to (+85^\circ)C</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>(-65^\circ)C to (+150^\circ)C</td>
</tr>
</tbody>
</table>

5. Exceeding any one or combination of these limits may cause permanent damage to this device.
6. MACOM does not recommend sustained operation near these survivability limits.
7. Operating at nominal conditions with \(T_J \leq +150^\circ\)C will ensure MTTF > \(1 \times 10^6\) hours. Thermal resistance, \(\Theta_{JC}\) is \(85^\circ\)C/W.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity
These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices with the following rating:
- HBM Class 1B
- CDM Class C5

Assembly Information
- Do not subject the device to excessive force, especially at elevated temperatures > \(60^\circ\)C.
- No-clean flux is required for assembly. Post SMT washing is not recommended.
- Additional handling information is contained on page 6.
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Typical Performance Curves

Conversion Loss USB (Down Conversion)
@ +25°C, IF = 100 MHz

Conversion Loss USB (Up Conversion)
@ +25°C, IF = 100 MHz

Conversion Loss Over Temperature, IF = 100 MHz

IF Bandwidth
@ +25°C, FLO = 10 GHz, PLO = 15 dBm
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Typical Performance Curves

**IIP3 @ LO Power, IF = 100 MHz**

![IIP3 Graph]

**IIP3 over temperature @ P_LO = 15 dBm, IF = 100 MHz**

![IIP3 Temperature Graph]

**IIP2 @ LO Power, IF = 100 MHz**

![IIP2 Graph]

**IIP2 over temperature @ P_LO = 15 dBm, IF = 100 MHz**

![IIP2 Temperature Graph]

**P1dB @ LO Power, IF = 100 MHz**

![P1dB Graph]
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Typical Performance Curves

Isolation (Down Conversion)
@ IF = 100 MHz, P_{LO} = 15 dBm; P_{RF} = -10 dBm

Isolation (Up Conversion)
@ IF = 100 MHz, P_{LO} = 15 dBm; P_{RF} = -10 dBm

RF Return Loss
@ +25°C, F_{LO} = 10 GHz, P_{LO} = 15 dBm

IF Return Loss
@ +25°C, F_{LO} = 10 GHz, P_{LO} = 15 dBm

MxN Spurious Rejection at IF Port (dBc IF)
RF = 10.1 GHz @ -10 dBm
LO = 10.0 GHz @ +15 dBm

<table>
<thead>
<tr>
<th>MxRF</th>
<th>0</th>
<th>1</th>
<th>2</th>
<th>3</th>
<th>4</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>x</td>
<td>16</td>
<td>42</td>
<td>18</td>
<td>22</td>
</tr>
<tr>
<td>1</td>
<td>20</td>
<td>0</td>
<td>44</td>
<td>61</td>
<td>49</td>
</tr>
<tr>
<td>2</td>
<td>91</td>
<td>84</td>
<td>75</td>
<td>78</td>
<td>91</td>
</tr>
<tr>
<td>3</td>
<td>80</td>
<td>97</td>
<td>83</td>
<td>74</td>
<td>83</td>
</tr>
<tr>
<td>4</td>
<td>x</td>
<td>x</td>
<td>x</td>
<td>x</td>
<td>92</td>
</tr>
</tbody>
</table>

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 Guidelines for Engineering Lab Assembly and Rework replacement

**A. Reflow Oven with Brand New PCB**
1. Apply paste evenly using screen to new PCB, or use manual dispenser (difficult to apply evenly).
2. Place component on top of solder paste, ensuring correct positioning relative to pin 1.
3. Set reflow oven to required profile for a leadfree paste, see profile in Application Note S2083.
4. Ensure correct speed of the conveyor belt (needs to be checked for a particular oven type).
5. Place remaining parts onto board.
6. Measure board.

**B. Replacing Existing Part with Hot Plate - Heat Applied Underneath the PCB**
(Recommend using a hot plate with localised heat to the mixer area).
1. Firstly prepare the new MAMX-011035 part to be installed.
2. Flip MAMX-011035 and apply a thin layer of solder on each pad. Ensure an appropriate amount of solder is applied to middle ground paddle also.
3. Next step is to remove existing mixer part already attached to the board.
4. Set the hot plate at 285°C temperature.
5. Place block underneath mixer from base plate to localise heat to mixer area only.
6. Remove existing mixer part when solder reflows.
7. Apply flux to PCB pins and centre ground area.
8. Ensure sufficient solder is visible on pads.
9. Align and position MAMX-011035 to correct position on PCB, relative to pin 1.
10. Observe solder reflow.
11. Then remove PCB from hot plate.
12. Allow to cool and measure.

- **Do not apply heat from above the MAMX-011035 with heat gun.**
- **Post SMT washing is not recommended.**
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Lead-Free 3 x 3 mm 12-Lead AQFN†

† Reference Application Note S2083 for lead-free solder reflow recommendations.
Meets JEDEC moisture sensitivity level 3 requirements.
Plating is NiPdAu
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